

December 2001 Revised January 2002

FIN1001

3.3V LVDS 1-Bit High Speed Differential Driver

General Description

This single driver is designed for high speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The driver translates LVTTL signal levels to LVDS levels with a typical differential output swing of 350 mV which provides low EMI at ultra low power dissipation even at high frequencies. This device is ideal for high speed transfer of clock or data.

The FIN1001 can be paired with its companion receiver, the FIN1002, or with any other LVDS receiver.

Features

- Greater than 600Mbs data rate
- 3.3V power supply operation
- 0.5ns maximum differential pulse skew
- 1.5ns maximum propagation delay
- Low power dissipation
- Power-Off protection
- Meets or exceeds the TIA/EIA-644 LVDS standard
- Flow-through pinout simplifies PCB layout
- 5-Lead SOT23 package saves space

Ordering Code:

Order Number	Package Number	Package Description
FIN1001M5	MA05B	5-Lead SOT23, JEDEC MO-178, 1.6mm [250 Units on Tape and Reel]
FIN1001M5X	MA05B	5-Lead SOT23, JEDEC MO-178, 1.6mm [3000 Units on Tape and Reel]

Pin Descriptions

Pin Name	Description		
D _{IN}	LVTTL Data Input		
D _{OUT+}	Non-inverting LVDS Driver Output		
D _{OUT}	Inverting LVDS Driver Output		
V _{CC}	Power Supply		
GND	Ground		
NC	No Connect		

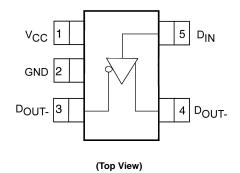
Function Table

Input	Outputs			
D _{IN}	D _{OUT+}	D _{OUT}		
L	L	Н		
Н	Н	L		

H = HIGH Logic Level L = LOW Logic Level

Connection Diagram

Pin Assignment for SOT23



Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions

 $\begin{array}{ll} \mbox{Driver Short Circuit Current (I_{OSD})} & \mbox{Continuous} \\ \mbox{Storage Temperature Range (T_{STG})} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \end{array}$

Max Junction Temperature (T_J) Lead Temperature (T_I)

(Soldering, 10 seconds) 260°C

ESD (Human Body Model) ≥ 7500V

ESD (Machine Model) ≥ 500V

 $\begin{array}{lll} \mbox{Supply Voltage (V}_{\mbox{CC}}) & 3.0\mbox{V to } 3.6\mbox{V} \\ \mbox{Input Voltage (V}_{\mbox{IN}}) & 0 \mbox{ to } \mbox{V}_{\mbox{CC}} \\ \mbox{Operating Temperature (T}_{\mbox{A}}) & -40\mbox{°C to } +85\mbox{°C} \\ \end{array}$

Note 1: The "Absolute Maximum Ratings": are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specification.

DC Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 2)	Max	Units
V _{OD}	Output Differential Voltage		250	350	450	mV
ΔV_{OD}	V _{OD} Magnitude Change from Differential LOW-to-HIGH	$R_1 = 100 \Omega$, See Figure 1			25	mV
Vos	Offset Voltage	INL = 100 sz, See rigule i	1.125	1.25	1.375	V
ΔV _{OS}	Offset Magnitude Change from Differential LOW-to-HIGH				25	mV
l _{OFF}	Power-Off Output Current	V _{CC} = 0V, V _{OUT} = 0V or 3.6V			±20	μΑ
los	Short Circuit Output Current	V _{OUT} = 0V		-5.5	-8	mA
		V _{OD} = 0V		±4	±8	IIIA
V _{IH}	Input HIGH Voltage		2.0		V _{CC}	V
V _{IL}	Input LOW Voltage		GND		0.8	V
I _{IN}	Input Current	V _{IN} = 0V or V _{CC}			±20	μΑ
I _{I(OFF)}	Power-Off Input Current	$V_{CC} = 0V$, $V_{IN} = 0V$ or 3.6V			±20	μΑ
V _{IK}	Input Clamp Voltage	I _{IK} = -18 mA	-1.5	-0.8		V
I _{cc}	Power Supply Current	No Load, V _{IN} = 0V or V _{CC}		4.5	8	mA
		$R_L = 100 \Omega$, $V_{IN} = 0V$ or V_{CC}		6.5	10	IIIA
C _{IN}	Input Capacitance	V _{CC} = 3.3V		3.2		pF
C _{OUT}	Output Capacitance	V _{CC} = 0V		3.3		pF

150°C

Note 2: All typical values are at $T_A = 25^{\circ}$ C and with $V_{CC} = 3.3$ V.

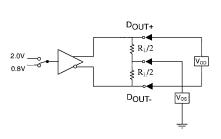
AC Electrical Characteristics

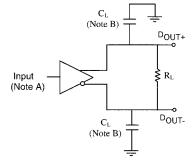
Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 3)	Max	Units
t _{PLHD}	Differential Propagation Delay LOW-to-HIGH		0.5	0.98	1.5	ns
t _{PHLD}	Differential Propagation Delay HIGH-to-LOW	$R_L = 100 \Omega$, $C_L = 10 pF$, See Figure 2 and Figure 3	0.5	0.93	1.5	ns
t _{TLHD}	Differential Output Rise Time (20% to 80%)		0.4	0.5	1.0	ns
t _{THLD}	Differential Output Fall Time (80% to 20%)		0.4	0.5	1.0	ns
t _{SK(P)}	Pulse Skew t _{PLH} - t _{PHL}			0.05	0.5	ns
t _{SK(PP)}	Part-to-Part Skew (Note 4)				1.0	ns

Note 3: All typical values are at $T_A = 25^{\circ}C$ and with $V_{CC} = 3.3V$.

Note 4: t_{SK(PP)} is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.





Note A: All input pulses have frequency = 10 MHz, t_R or t_F = 2 ns Note B: C_L includes all probe and fixture capacitances

FIGURE 1. Differential Driver DC Test Circuit

FIGURE 2. Differential Driver Propagation Delay and Transition Time Test Circuit

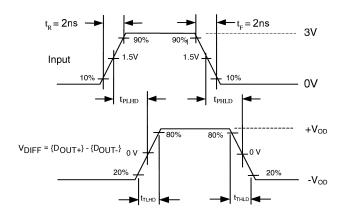
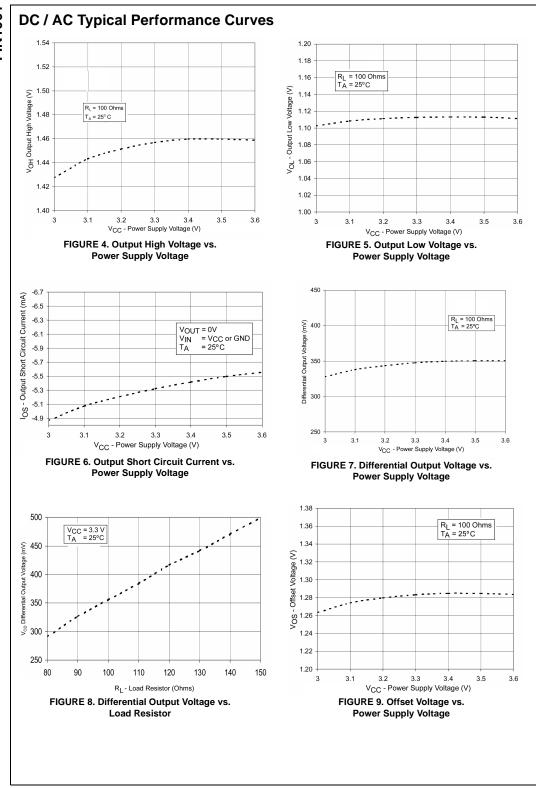
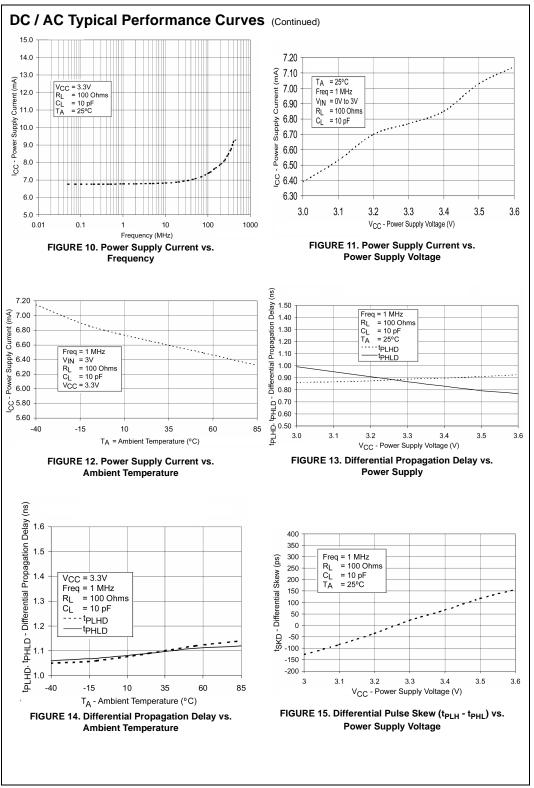


FIGURE 3. AC Waveforms





DC / AC Typical Performance Curves (Continued)

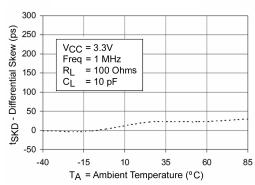


FIGURE 16. Differential Pulse Skew (t_{PLH} - t_{PHL}) vs. Ambient Temperature

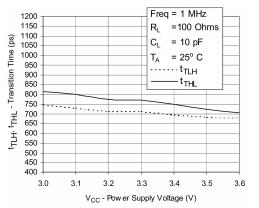


FIGURE 17. Transition Time vs. Power Supply Voltage

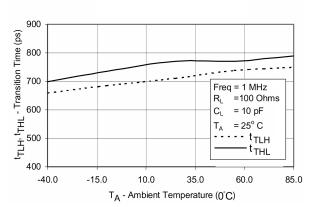


FIGURE 18. Transition Time vs. Ambient Temperature

$\label{physical Dimensions} \textbf{Physical Dimensions} \ \ \textbf{inches} \ \ \textbf{(millimeters)} \ \ \textbf{unless otherwise noted}$ 3.00 2.80 -[A] 0.95 0.95 В 3.00 2.60 2.60 **♦** 0.20 **№** C A B 0.70 LAND PATTERN RECOMMENDATION SEE DETAIL A C 0.10 C NOTES: UNLESS OTHERWISE SPECIFIED A) THIS PACKAGE CONFORMS TO JEDEC MO-178, ISSUE B, VARIATION AA, DATED JANUARY 1999. GAGE PLANE B) ALL DIMENSIONS ARE IN MILLIMETERS. 0.25 0.55 SEATING PLANE 0.60 REF MA05BRevC DETAIL A

5-Lead SOT23, JEDEC MO-178, 1.6mm Package Number MA05B

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